

CAMPUSplastics | datasheet Stanyl® TW341



This datasheet of **Stanyl® TW341** from **DSM Engineering Plastics** is provided by the international plastics database **CAMPUS**.

CAMPUS is organized by a group of leading international resin producers, who have agreed to test their material according to uniform conditions, based on ISO standards (ISO 10350, ISO 11403), in order to offer comparable data to the market.

Stanyl® TW341 | PA46 | DSM Engineering Plastics

Product Texts

Heat Stabilized, Lubricated

ISO 1043 PA46

Welcome to the astonishing world of Stanyl®

Mechanical properties

	dry / cond	Unit	Test Standard
Tensile Modulus	3300 / 1000	MPa	ISO 527-1/-2
Yield stress	100 / 55	MPa	ISO 527-1/-2
Yield strain	10 / 20	%	ISO 527-1/-2
Nominal strain at break	40 / >50	%	ISO 527-1/-2
Tensile creep modulus (1000h)	* / 550	MPa	ISO 899-1
Charpy impact strength (+23°C)	N / N	kJ/m ²	ISO 179/1eU
Charpy impact strength (-30°C)	N / N	kJ/m ²	ISO 179/1eU
Charpy notched impact strength (+23°C)	10 / 35	kJ/m ²	ISO 179/1eA
Charpy notched impact strength (-30°C)	4 / 4	kJ/m ²	ISO 179/1eA

Thermal properties

	dry / cond	Unit	Test Standard
Melting temperature (10°C/min)	295 / *	°C	ISO 11357-1/-3
Glass transition temperature (10°C/min)	75 / *	°C	ISO 11357-1/-2
Temp. of deflection under load (1.80 MPa)	190 / *	°C	ISO 75-1/-2
Temp. of deflection under load (0.45 MPa)	280 / *	°C	ISO 75-1/-2
Vicat softening temperature (50°C/h 50N)	290 / *	°C	ISO 306
Coeff. of linear therm. expansion (parallel)	85 / *	E-6/K	ISO 11359-1/-2
Coeff. of linear therm. expansion (normal)	110 / *	E-6/K	ISO 11359-1/-2
Burning Behav. at 1.5 mm nom. thickn.	V-2 / *	class	IEC 60695-11-10
Thickness tested	1.5 / *	mm	IEC 60695-11-10
UL recognition	UL / *	-	-
Burning Behav. at thickness h	V-2 / *	class	IEC 60695-11-10
Thickness tested	0.8 / *	mm	IEC 60695-11-10
UL recognition	UL / *	-	-
Oxygen index	27 / *	%	ISO 4589-1/-2

Electrical properties

	dry / cond	Unit	Test Standard
Relative permittivity (100Hz)	3.9 / 22	-	IEC 60250
Relative permittivity (1MHz)	3.6 / 4.5	-	IEC 60250
Dissipation factor (100Hz)	70 / 8700	E-4	IEC 60250
Dissipation factor (1MHz)	260 / 1200	E-4	IEC 60250
Volume resistivity	1E13 / 1E7	Ohm*m	IEC 60093
Surface resistivity	* / 1E13	Ohm	IEC 60093
Electric strength	25 / 15	kV/mm	IEC 60243-1
Comparative tracking index	400 / -	-	IEC 60112

Other properties

	dry / cond	Unit	Test Standard
Water absorption	13.5 / *	%	Sim. to ISO 62
Humidity absorption	3.7 / *	%	Sim. to ISO 62
Density	1180 / -	kg/m ³	ISO 1183

Material specific properties

	dry / cond	Unit	Test Standard
Viscosity number	185 / *	cm ³ /g	ISO 307, 1157, 1628

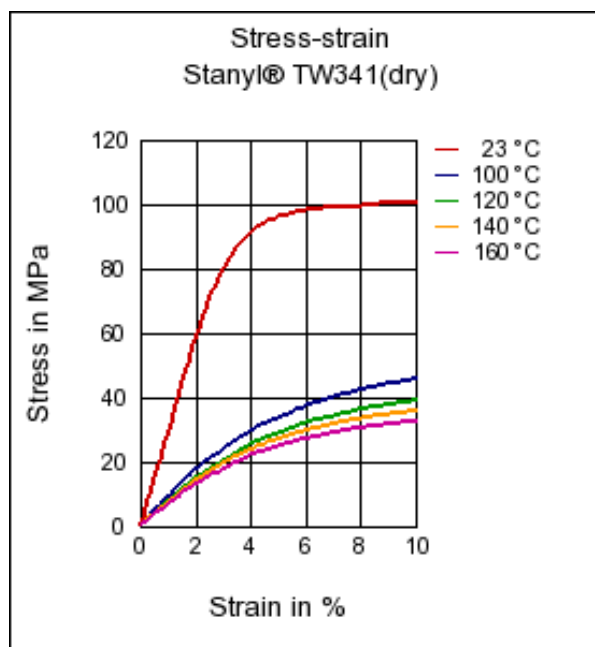
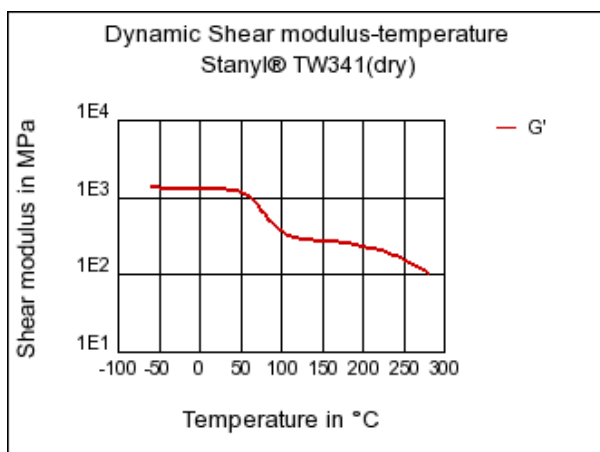
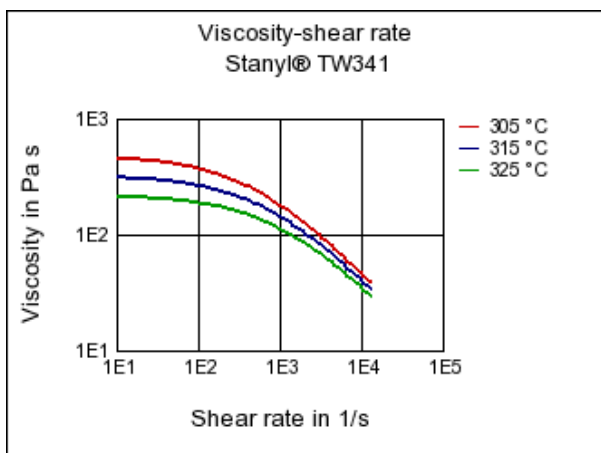
Rheological calculation properties

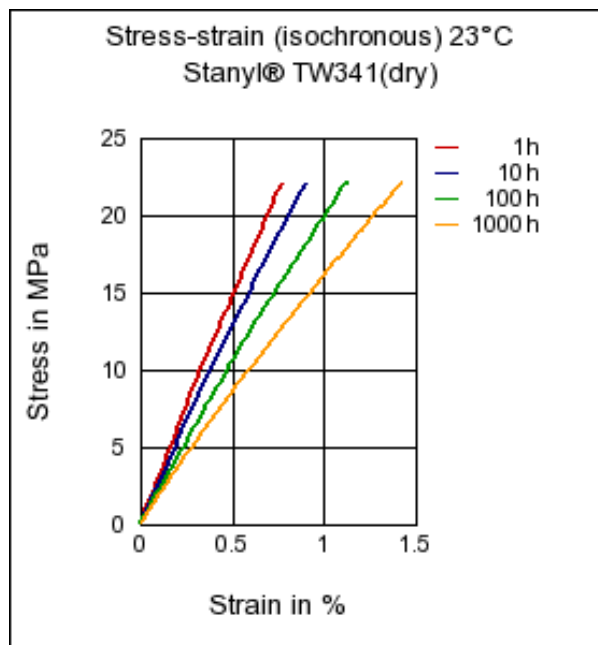
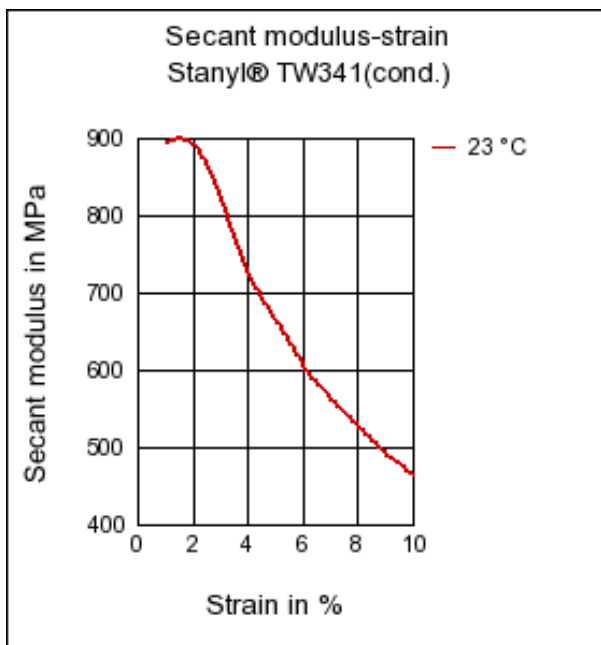
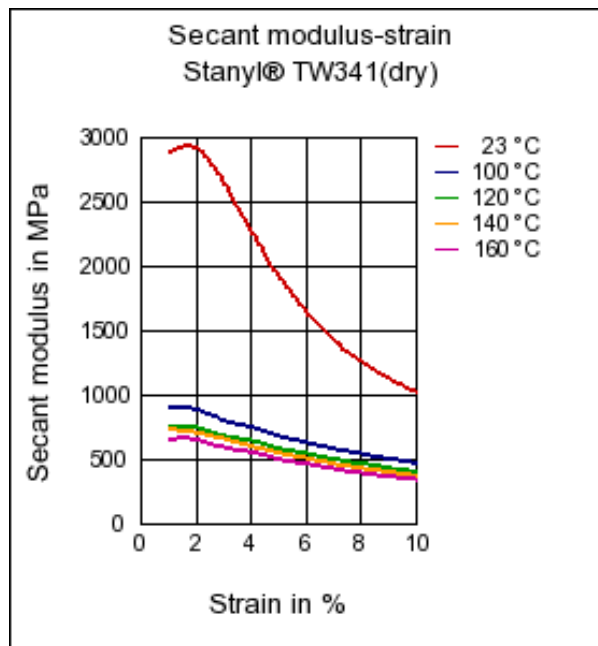
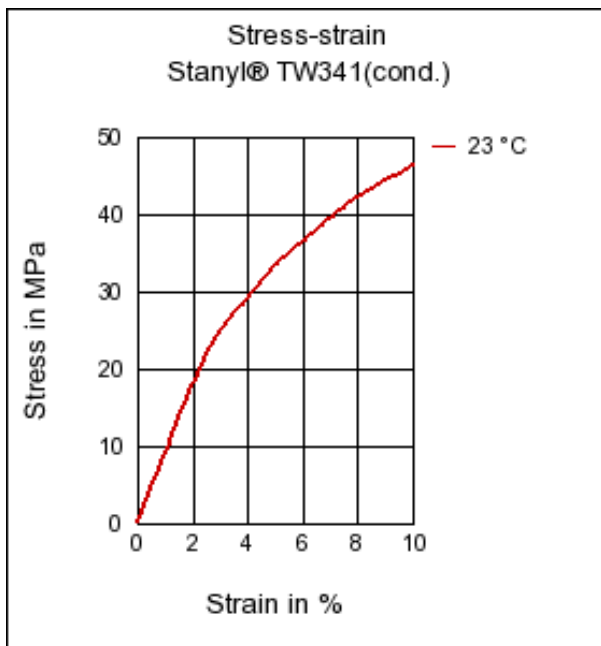
	Value	Unit	Test Standard
Density of melt	978	kg/m ³	-
Thermal conductivity of melt	0.252	W/(m K)	-

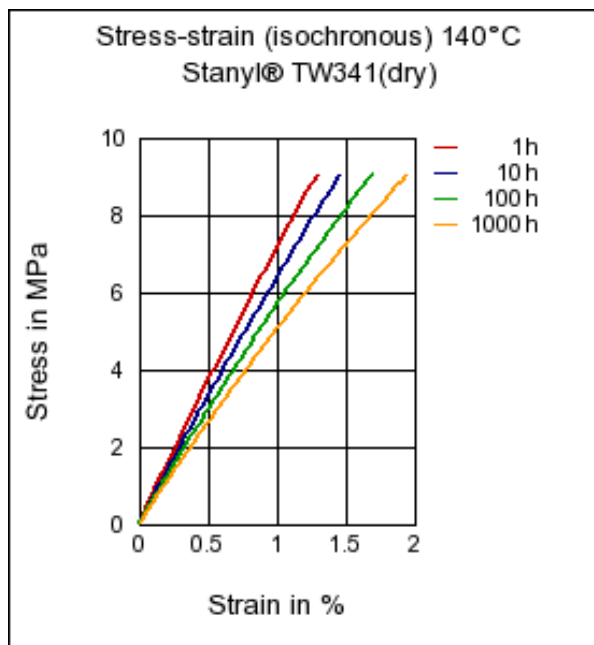
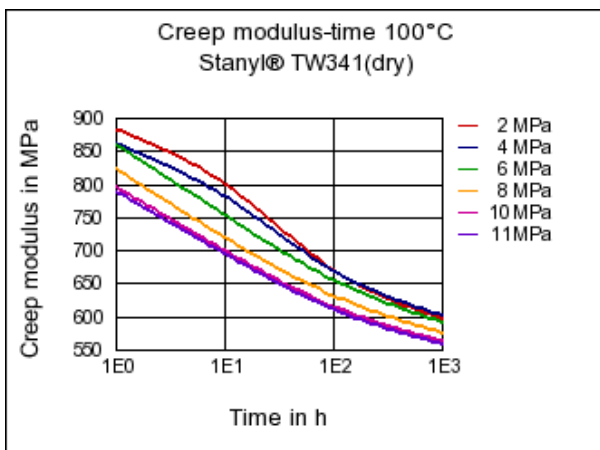
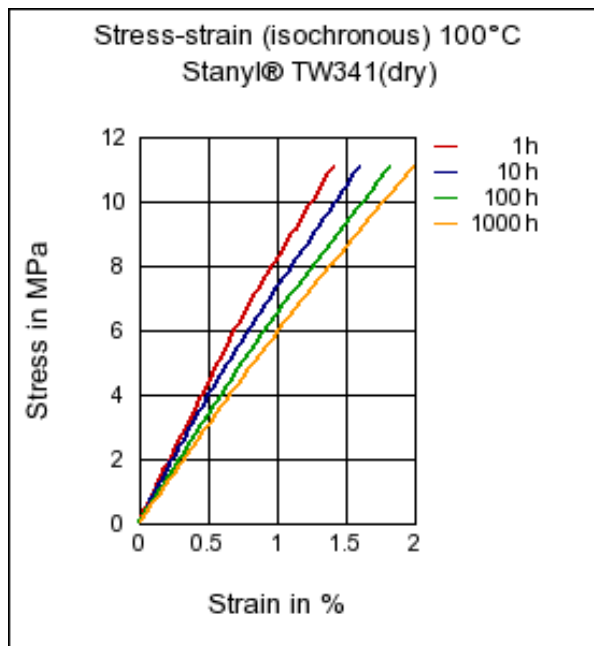
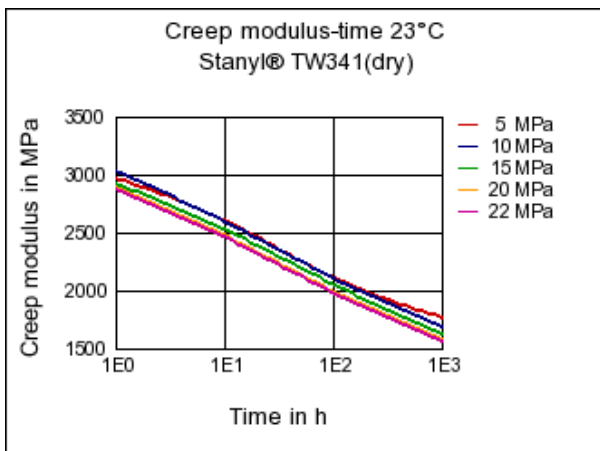
Spec. heat capacity melt
 Eff. thermal diffusivity

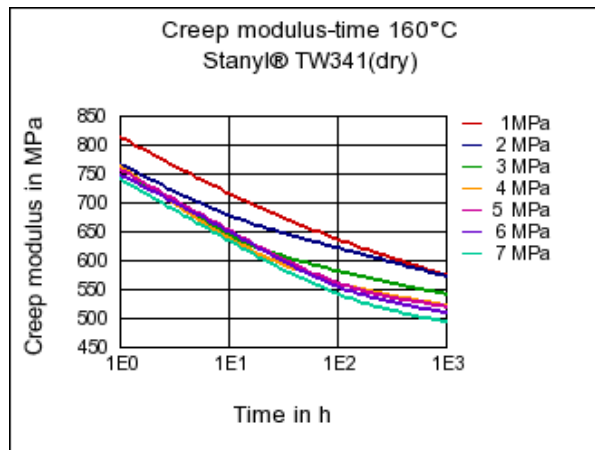
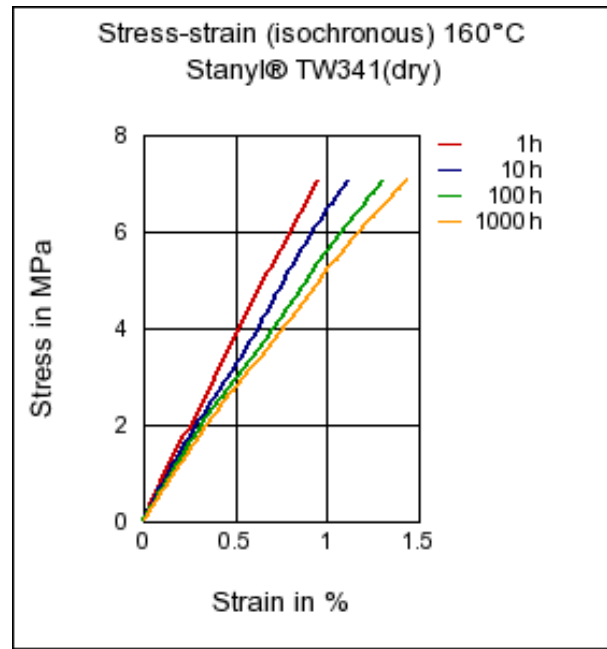
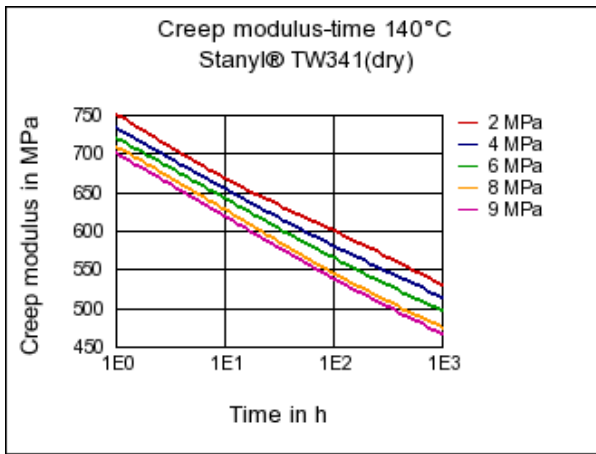
2800 J/(kg K) -
 9.21E-8 m²/s -

Diagrams









Characteristics

Processing

Injection Molding

Delivery form

Pellets

Additives

Lubricants, Release agent

Special Characteristics

Platable, Heat stabilized or stable to heat

Regional Availability

North America, Europe, Asia Pacific

Other text information

Injection molding

Injection Molding Recommendations

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